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# MITIGATION OF DIELECTRIC HEATING OF PIEZOELECTRIC ACTUATORS AT **CRYOGENIC TEMPERATURES**

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Abstract

The new generation of low beam intensity superconducting linacs will require high accelerating gradients for new scientific discoveries. The high accelerating gradient cavities in pulsed SRF linacs will experience large (~1000's of Hz) detuning caused by Lorentz force detuning (LFD). The piezo actuators that will be used to compensate large LFD must operate at a nominal voltage of 120V to 150V to deliver the required stroke to the cavity. In this high voltage range, the piezo is expected to warm up drastically due to its location in an insulating vacuum environment. Overheating of the piezo will significantly decrease the longevity of the actuator. A collaboration between FNAL and Physik Instrumente (PI) developed a novel piezo actuator design that mitigates piezo over-heating. The design consists of using a metal foam in contact with the piezoelectric ceramic stack for heat removal. The second solution used lithium niobite as an alternative material. A comparison of the temperature stability will be presented and discussed. This study characterizes the dielectric properties for both materials. The results obtained are in the temperature range of 10 K to 300 K.

#### Slim Blade Tuner



- For a linac in pulse operation the main source of detuning is caused by radiation pressure known as Lorentz force detuning (LFD).
- This can result in a frequency shift of -500 Hz to -3 kHz depending on the cavity.
- To compensate for pulse linac operation detuning a larger V pp on the order of 120 V-150 V and
- Table 2: Maximum temperature of the standard PICMA® and the copper (cu) foam actuator without a heatsink attached.

|                                  | Standard<br>PICMA®<br>Design |     | Cu Foam<br>Design W/O<br>Heat Sink |     |
|----------------------------------|------------------------------|-----|------------------------------------|-----|
|                                  |                              |     |                                    |     |
| nitial Temp [K]                  | 20                           | 77  | 14                                 | 77  |
| T <sup>max</sup><br>Ceramic [K]] | 110                          | 183 | 29                                 | 120 |
| $T_{Shell}^{max}\left[K ight]$   | 71                           | 131 | 21                                 | 96  |

The results for the copper foam without the heat sink at both 4 K and 77 K operation are shown in Table 2.

Novel Piezo Design

The temperature difference between the sensor on the ceramic  $(T_{max}^{Ceramic})$  and the one on the capsule shell  $(T_{max}^{Shell})$  is another proxy for calculating the heat transfer improvement.



frequencies of 200-300 Hz is needed.

Figure 1: Top: example of piezo location in double lever tuner of 650 MHz elliptical cavity. Bottom: cross-sectional view.

• The piezo actuators are made from lead zirconate titanate (PZT). PZT has a thermal conductivity of 4 W/(m·K) at room temperature and this drops to 0.02 W/(m·K) at 20 K which makes heat transfer difficult.

### Novel Piezo Design





Figure 2: Setup of piezo on the copper disk. The temperature sensors are located inside the actuators. Two heat sinks are used and two accelerometers

Figure 3: Cross-sectional view of the two piezo designs. One is the new piezo design with copper foam and the other is the standard design.

- A small temperature difference between the capsule shell and the piezoceramic indicates that there is good heat flow. For the standard PICMA® design cooled with liquid helium and operated at 100 Hz at  $V_{pp}$ = 100 V the temperature difference from the inside to the outside encapsulation is 40 K.
- Under the same operation, the copper foam piezo with the heat sink had a temperature difference is 8 K. A smaller temperature difference from the ceramic to the piezo encapsulation show that the thermal heat transfer improved.

## $LiNbO_3$ Piezo Actuator

Table 3: Piezoelectric properties for *LiNbO3* and PZT actuators used in this paper.

|  | PIC 050            | PIC 255/252 |
|--|--------------------|-------------|
| Material   | LiNbO <sub>3</sub> | PZT         |
| Length [mm]                                      | 36                 | 18          |
| Cross-section $[mm^2]$                           | 100                | 100         |
| Stroke (300 K) [µm]                              | 3                  | 18          |
| Stiffness [N/µm]                                 | 195                | 200         |
| Blocking Force (300 K) [N]                       | 585                | 3600        |
| Curie Temperature [K]                            | 1423               | 623         |
| Density $\rho$ [g/cm <sup>-3</sup> ]             | 5                  | 7.80        |
| Relative Permittivity $\epsilon_{33}/\epsilon_0$ | 28.7               | 1750        |
|  |                    |             |



Figure 6: The capacitance and dissipation factor are measured with an LCR for the lithium niobate piezo at 1 kHz at Vpp=1 V.

- At  $V_{pp}$  = 1000 V with a sine wave of 200 Hz the temperature on the outside of the capsule increased by 0.1 K as shown in Fig. 6.



Figure 4: Simulation of heating of piezo with and without copper foam in contact with the ceramic (courtesy of PI).

Table 1: Data for trials with liquid nitrogen (LN2) and liquid helium (LHe). The temperature rise on the ceramic is given when the piezo is stimulated with a 100 Hz sinewave at different voltages.

|       |             | Standard<br>PICMA® | Copper<br>Foam | - |
|-------|-------------|--------------------|----------------|---|
|       |             | Design             | Design         |   |
| Trial | Voltage [V] | $\Delta T [K]$     | $\Delta T [K]$ | - |
| LN2   | 50          | 6                  | 2.01           |   |
|       | 100         | 105                | 18.92          |   |
|       | 50          | 2.47               | 0.92           |   |



Figure 5: Temperature rise of copper foam piezo modulated with 100 Hz sine wave at different voltages

- The design of the new piezo consists of placing copper foam contact the ceramic and the outer encasing of the piezo actuator.
- Since the piezo ceramic will be operated at high voltage, a dielectric is used as a buffer between the connections of the copper foam in the ceramic and outer actuator encapsulation (see Fig. 3).
  - nitride Aluminum similar has properties to sapphire, it has high thermal conductivity and small



The stroke of the PZT piezo with both stacks at a temperature of 12 K will be reduced to 9.72 µm at 100 V. At 1000 V and at 12 K the stroke of the LiNbO<sub>3</sub> piezo is reduced to 2.76  $\mu$ m.

The typical frequency sensitivity of an SRF cavity is 200 to 300  $\frac{Hz}{\mu m}$ . The LiNbO<sub>3</sub> actuator can thus compensate up to 552 Hz of detuning.

#### Conclusion

- A novel piezoelectric actuator design was developed and tested yielding a reduction of heating by a factor of 14 at liquid helium temperatures.
- This new design also succeeded in stopping the positive thermal feedback. These contractions cause stress on the ceramic, by preventing large temperature fluctuations due to heating the PZT copper foam design improves the lifetime.
- The properties of an actuator made from the lithium niobite piezo ceramic were studied for use in SRF cavity resonance control for the first time. The lithium niobate piezo ceramic actuator shows no heating but with a compromise of a smaller displacement stroke.

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